

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4546798

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
LAKSHESWAR KALITA	03/03/2017
PRERNA S. GORADIA	08/10/2017
GEETIKA BAJAJ	03/09/2017
YOGITA PAREEK	06/16/2017
YIXING LIN	08/11/2017
DMITRY LUBOMIRSKY	07/10/2017
ANKUR KADAM	03/09/2017
BIPIN THAKUR	08/04/2017
KEVIN A. PAPKE	06/19/2017
KAUSHIK VAIDYA	06/18/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	APPLIED MATERIALS, INC.
<b>Street Address:</b>	3050 BOWERS AVENUE
<b>City:</b>	SANTA CLARA
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	95054
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15451995
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(713)623-4846
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	7136234844
<b>Email:</b>	hhenderson@pattersonsheridan.com, psdocketing@pattersonsheridan.com
<b>Correspondent Name:</b>	PATTERSON & SHERIDAN, LLP
<b>Address Line 1:</b>	24 GREENWAY PLAZA, SUITE 1600
<b>Address Line 4:</b>	HOUSTON, TEXAS 77046
<b>ATTORNEY DOCKET NUMBER:</b>	APPM/023711US

<b>NAME OF SUBMITTER:</b>	CHAD M. DOUGHERTY
<b>SIGNATURE:</b>	/Chad M. Dougherty/
<b>DATE SIGNED:</b>	08/11/2017
<b>Total Attachments: 12</b> source=023711US_ASSIGNMENT_EF#page1.tif source=023711US_ASSIGNMENT_EF#page2.tif source=023711US_ASSIGNMENT_EF#page3.tif source=023711US_ASSIGNMENT_EF#page4.tif source=023711US_ASSIGNMENT_EF#page5.tif source=023711US_ASSIGNMENT_EF#page6.tif source=023711US_ASSIGNMENT_EF#page7.tif source=023711US_ASSIGNMENT_EF#page8.tif source=023711US_ASSIGNMENT_EF#page9.tif source=023711US_ASSIGNMENT_EF#page10.tif source=023711US_ASSIGNMENT_EF#page11.tif source=023711US_ASSIGNMENT_EF#page12.tif	

**ASSIGNMENT FOR APPLICATION FOR PATENT**

WHEREAS:

Names and Addresses of Inventors:

1)	Laksheswar KALITA Elitra F, 1004 Casa Bella Gold Lodha Dombivili (E) Mumbai-421204 INDIA	2)	Prema A. GORADIA 501 Chandan, S.V. Road Vile Parle (W) Mumbai-400056 INDIA
3)	Geetika BAJAJ 3/63 A. Moti Nagar New Delhi-110015 INDIA	4)	Yogita PAREEK 88B, Bodh VPhar, Chomu Jaipur-303702 INDIA
5)	Yixing LIN 18026 King Court Saratoga, California 95070	6)	Dmitry LUBOMIRSKY 862 Bette Avenue Cupertino, California 95014
7)	Ankur KADAM B-1201, Prakruti Pearl Hiranandani Estate Ghodbunder Road, Thane (W) Mumbai-400607; INDIA	8)	Bipin THAKUR Yajurved Building II 2nd Floor Dr. Bhayandarkar Lane, Boile Road Dadar, Mumbai-400028; INDIA
9)	Kevin A. PAPKE 745 Schiele Avenue San Jose, California 95126	10)	Kaushik VAIDYA 23 Adarsh Vista Basavanagar Main Road Vibhuthipura Bangalore-37; INDIA

(hereinafter referred to as Assignors), have invented a certain invention entitled:

**METHOD FOR ELECTROCHEMICALLY GROWN YTTRIA OR YTTRIUM OXIDE ON SEMICONDUCTOR PROCESSING EQUIPMENT**

for which application for Letters Patent in the United States was filed on March 7, 2017, under Serial No. 15/451,995, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all

rights to apply for patents on said invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, conventional, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.

4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	<u>3<sup>rd</sup> March, 2017</u> (DATE)	<u>LAKSHESWAR</u> Laksheswar KALITA
2)	<u>3-9-17</u> (DATE)	<u>[Signature]</u> Prerna DORADIA
3)	<u>9/3/17</u> (DATE)	<u>[Signature]</u> Geetika BAJAJ
4)	_____ (DATE)	Yogita PAREEK
5)	_____ (DATE)	Yixing LIN
6)	_____ (DATE)	Dmitry LUBOMIRSKY
7)	<u>9<sup>th</sup> March 2017</u> (DATE)	<u>[Signature]</u> Ankur KADAM
8)	_____ (DATE)	<u>[Signature]</u> Bipin THAKUR
9)	_____ (DATE)	Kevin A. PAPKE

Atty Dkt No.: 023711USA/AGS/SERVICE/PJT

10) ..... (DATE)

\_\_\_\_\_  
Kaushik VAIDYA

**ASSIGNMENT FOR APPLICATION FOR PATENT**

WHEREAS:

Names and Addresses of Inventors:

1)	Laksheswar KALITA Elitra F, 1004 Casa Bella Gold Lodha Dombivili (E) Mumbai-421204 INDIA	2)	Prema S. GORADIA 501 Chandan, S.V. Road Vile Parle (W) Mumbai-400056 INDIA
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9)	Kevin A. PAPKE 745 Schiele Avenue San Jose, California 95126	10)	Kaushik VAIDYA 23 Adarsh Vista Basavanagar Main Road Vibhuthipura Bangalore-37; INDIA

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rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

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4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	_____ (DATE)	_____
	8/10/2017	Laksheswar KALITA
2)	_____ (DATE)	DocuSigned by: <i>Prerna S. Goradia</i>
		47E3A2C9E69E498...
3)	_____ (DATE)	_____
		Geetika BAJAJ
4)	_____ (DATE)	_____
		Yogita PAREEK
5)	_____ (DATE)	_____
		Yixing LIN
6)	_____ (DATE)	_____
		Dmitry LUBOMIRSKY
7)	_____ (DATE)	_____
		Ankur KADAM
8)	_____ (DATE)	_____
		Bipin THAKUR
9)	_____ (DATE)	_____
		Kevin A. PAPKE

10) \_\_\_\_\_ (DATE)

\_\_\_\_\_  
Kaushik VAIDYA



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Names and Addresses of Inventors:

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Laksheswar KALITA

2) \_\_\_\_\_ (DATE) \_\_\_\_\_  
Prema A. GORADIA

3) \_\_\_\_\_ (DATE) \_\_\_\_\_  
Geetika BAJAJ

4) 6/16/2017 (DATE) \_\_\_\_\_  
  
Yogita PAREEK

5) 8/11/2017 (DATE) \_\_\_\_\_  
  
Yixing LIN

6) 7/10/2017 \_\_\_\_\_ (DATE)

DocuSigned by:  
*Dmitry Lubomirsky*  
03B2AA04A0054D9...

7) \_\_\_\_\_ (DATE)

\_\_\_\_\_  
Ankur KADAM

8) \_\_\_\_\_ (DATE)

\_\_\_\_\_  
Bipin THAKUR

9) 6/19/2017 \_\_\_\_\_ (DATE)

DocuSigned by:  
*Kevin A. Papke*  
75A064B5BE67486...  
Kevin A. PAPKE

10) 6/18/2017 \_\_\_\_\_ (DATE)

DocuSigned by:  
*Kaushik Vaidya*  
6FB0CD456A31408...  
KAUSHIK VAIDYA

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- 6) \_\_\_\_\_ (DATE) \_\_\_\_\_  
Dmitry LUBOMIRSKY
- 7) \_\_\_\_\_ (DATE) \_\_\_\_\_
- 8) 8/4/2017 \_\_\_\_\_ (DATE) \_\_\_\_\_  
Ankur KADAM  
DocuSigned by:  
*Bipin Thakur*  
6438A9AA7D1C438...
- 9) \_\_\_\_\_ (DATE) \_\_\_\_\_  
Kevin A. PAPKE

10) \_\_\_\_\_ (DATE)

\_\_\_\_\_  
Kaushik VAIDYA